

* NOTICES *

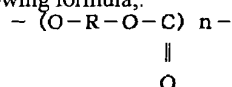
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 CLAIMS

[Claim(s)]

[Claim 1] a) Following formula:



polymer with the polycarbonate structure of having the repeat unit expressed with (R is the hydrocarbon group of the shape of a straight chain of carbon numbers 2-20, and the letter of branching), and b -- the thermally conductive pressure sensitive adhesive characterized by including the thermally conductive filler of the rate which serves as the 10 - 300 weight section to this polymer 100 weight section

[Claim 2] The thermally conductive pressure sensitive adhesive according to claim 1 with which polymer with the polycarbonate structure of a component consists of with a weight average molecular weight of 10,000 or more compounded from the dicarboxylic-acid component which made indispensable the dicarboxylic acid to which the diol component which made the polycarbonate diol indispensable, and a carbon number make a molecule skeleton the hydrocarbon group of the aliphatic series of 2-20, or an alicycle group polyester.

[Claim 3] The adhesion sheets which come to prepare the layer of a thermally conductive pressure sensitive adhesive according to claim 1 or 2 in one side or both sides of a thermally conductive base material

[Translation done.]